IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)			
Youzhi E. Xu)	Examiner: Fischer, Justin R.		
U.S. Serial No:		10/781,314)	Art Unit: 1793	1	
Filed:		02/17/2004)	Confirmation:	4855	
For:	r: HEAT TRANSFER THROUGH COVALENT BONDING OF THERMAL INTERFACE MATERIAL)))			
P.O. I	missioner for Box 1450 ndria, VA 23		, , , , , , , , , , , , , , , , , , ,			

AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed February 25, 2009. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

I hereby certify that this correspondence is being deposited with the United States Patent and Trademark Office via electronic filing through the United States Patent and Trademark Electronic Filing System on: | May 19 2009 | | Date of Person Filing Correspondence | Name of Person Filing Correspondence | May 19 2009 | | Signature | Date | Date | Date |